

# PTVA092407NF

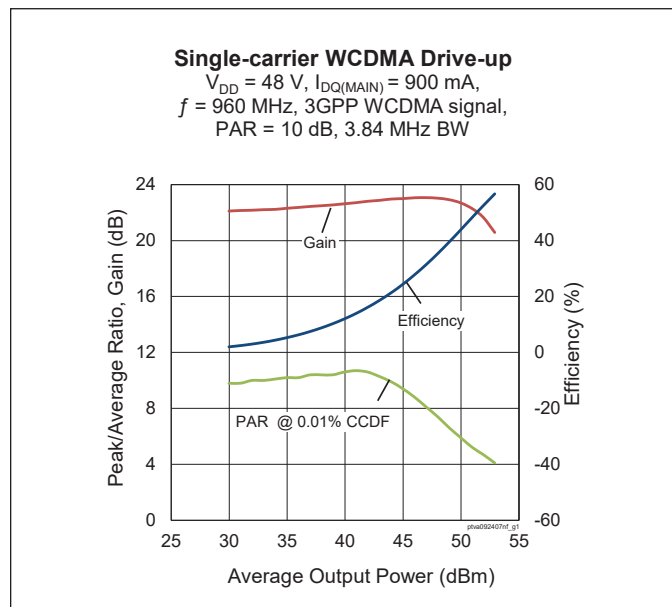
Thermally-Enhanced High Power RF LDMOS FET  
240 W, 48 V, 869 – 960 MHz



Package Types: PG-HBSOF-4-2

## Description

The PTVA092407NF is a 240-watt LDMOS FET manufactured with Wolfsped's 48-V LDMOS process. It is designed for use in multi-standard cellular power amplifier applications. It features a single ended design and input and output matching that allow for use from 869 MHz to 960 MHz. Manufactured with Wolfsped's advanced LDMOS process, this device provides excellent thermal performance and superior reliability.



## Features

- Broadband internal input and output matching
- Typical CW performance, 960 MHz, 48 V, 10  $\mu\text{s}$  pulse width, 10% duty cycle, single side
  - Output power at  $P_{1dB} = 240\text{ W}$
  - Output power at  $P_{3dB} = 287\text{ W}$
  - Gain = 20 dB
  - Efficiency = 62%
- Capable of handling 10:1 VSWR @ 48 V, 80 W CW output power
- Integrated ESD protection
- Human Body Model class 2 (per ANSI/ESDA/ JEDEC JS-001)
- Low thermal resistance
- Pb-free and RoHS compliant

## RF Characteristics

### Single-carrier WCDMA Specifications (tested in Wolfsped production test fixture)

$V_{DD} = 48\text{ V}$ ,  $I_{DQ} = 900\text{ mA}$ ,  $P_{OUT} = 80\text{ W}$  avg,  $f = 960\text{ MHz}$ , 3GPP signal, channel bandwidth = 3.84 MHz, peak/average = 10 dB @ 0.01% CCDF

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Linear Gain	$G_{ps}$	21.3	22.5	—	dB
Drain Efficiency	$\eta_D$	38	40	—	%
Adjacent Channel Power Ratio	ACPR	—	-30	-28.5	dBc
Output PAR @ 0.01% CCDF	OPAR	5.7	6.2	—	dB

Note:

All published data at  $T_{CASE} = 25^\circ\text{C}$  unless otherwise indicated

ESD: Electrostatic discharge sensitive device—observe handling precautions!





## DC Characteristics

Characteristic	Symbol	Min.	Typ.	Max.	Unit	Conditions
Drain-Source Breakdown Voltage	$V_{BR(DSS)}$	105	—	—	V	$V_{GS} = 0\text{ V}, I_{DS} = 10\text{ mA}$
Drain Leakage Current	$I_{DSS}$	—	—	1	$\mu\text{A}$	$V_{DS} = 50\text{ V}, V_{GS} = 0\text{ V}$
		—	—	10		$V_{DS} = 105\text{ V}, V_{GS} = 0\text{ V}$
Gate Leakage Current	$I_{GSS}$	—	—	1		$V_{GS} = 10\text{ V}, V_{DS} = 0\text{ V}$
On-State Resistance	$R_{DS(on)}$	—	0.13	—	$\Omega$	$V_{GS} = 10\text{ V}, V_{DS} = 0.1\text{ V}$
Operating Gate Voltage	$V_{GS}$	3.3	3.7	4.1	V	$V_{DS} = 48\text{ V}, I_{DQ} = 900\text{ mA}$

## Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-source Voltage	$V_{DSS}$	105	V
Gate-source Voltage	$V_{GS}$	-6 to +12	
Operating Voltage	$V_{DD}$	0 to +55	
Junction Temperature	$T_J$	225	$^{\circ}\text{C}$
Storage Temperature Range	$T_{STG}$	-65 to +150	

1. Operation above the maximum values listed here may cause permanent damage. Maximum ratings are absolute ratings; exceeding only one of these values may cause irreversible damage to the component. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. For reliable continuous operation, the device should be operated within the operating voltage range ( $V_{DD}$ ) specified above.

2. Parameters values can be affected by end application and product usage. Values may change over time.

## Thermal Characteristics

Parameter	Symbol	Value	Unit	Conditions
Thermal Resistance (Main)	$R_{\theta JC}$	0.29	$^{\circ}\text{C}/\text{W}$	$T_{CASE} = 70^{\circ}\text{C}, 240\text{ W CW}$

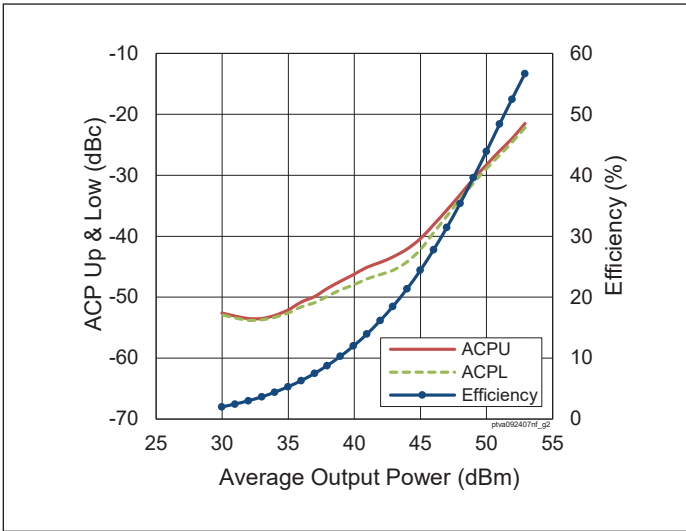
## Moisture Sensitivity Level

Level	Test Signal	Package Temperature	Unit
3	IPC/JEDEC J-STD-020	260	$^{\circ}\text{C}$

## Ordering Information

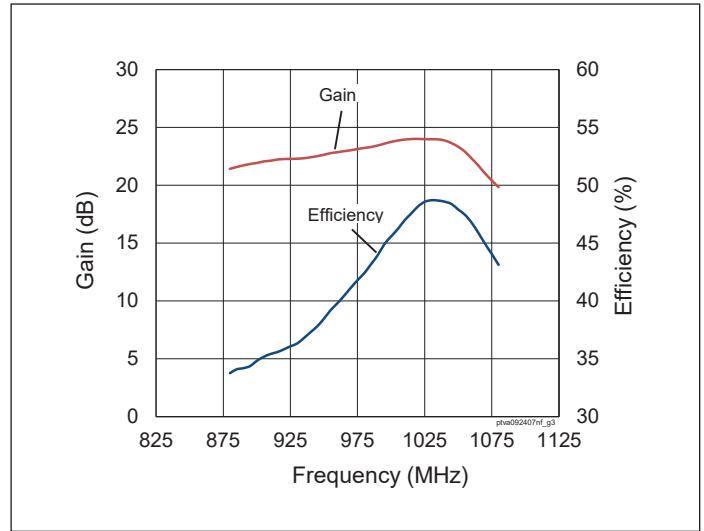
Type and Version	Order Code	Package Description	Shipping
PTVA092407NF V2 R5	PTVA092407NF-V2-R5	PG-HBSOF-4-2, plastic package	Tape & Reel, 500 pcs

**Typical RF Performance** (data taken in production test fixture)



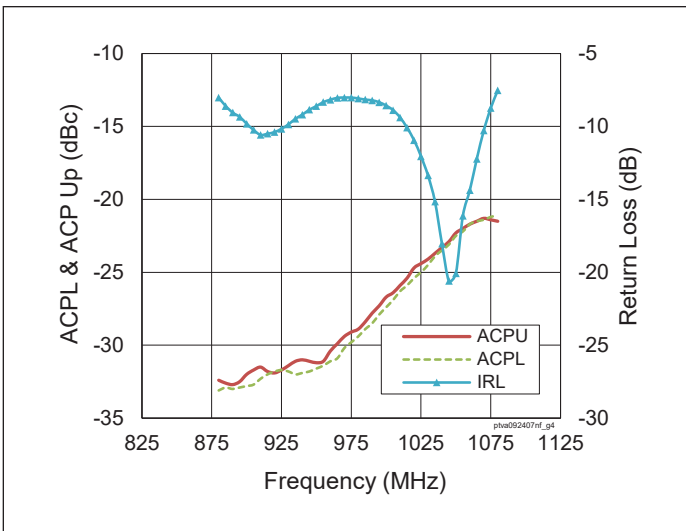
**Figure 1.** Single-carrier WCDMA Drive-up

$V_{DD} = 48\text{ V}$ ,  $I_{DQ(MAIN)} = 900\text{ mA}$ ,  $f = 960\text{ MHz}$   
 3GPP WCDMA signal, PAR = 10 dB,  
 BW = 3.84 MHz



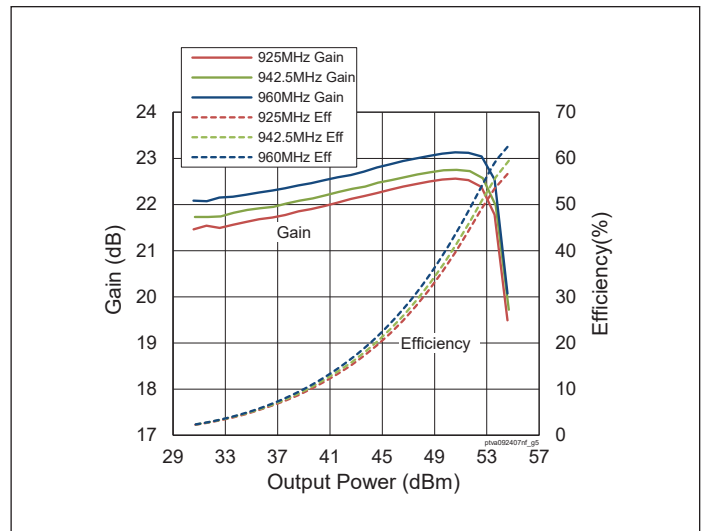
**Figure 2.** Single-carrier WCDMA Broadband Performance

$V_{DD} = 48\text{ V}$ ,  $I_{DQ(MAIN)} = 900\text{ mA}$ ,  
 $P_{OUT} = 49\text{ dBm}$ , 3GPP WCDMA signal,  
 PAR = 10 dB



**Figure 3.** Single-carrier WCDMA Broadband Performance

$V_{DD} = 48\text{ V}$ ,  $I_{DQ(MAIN)} = 900\text{ mA}$ ,  
 $P_{OUT} = 49\text{ dBm}$ , 3GPP WCDMA signal,  
 PAR = 10 dB

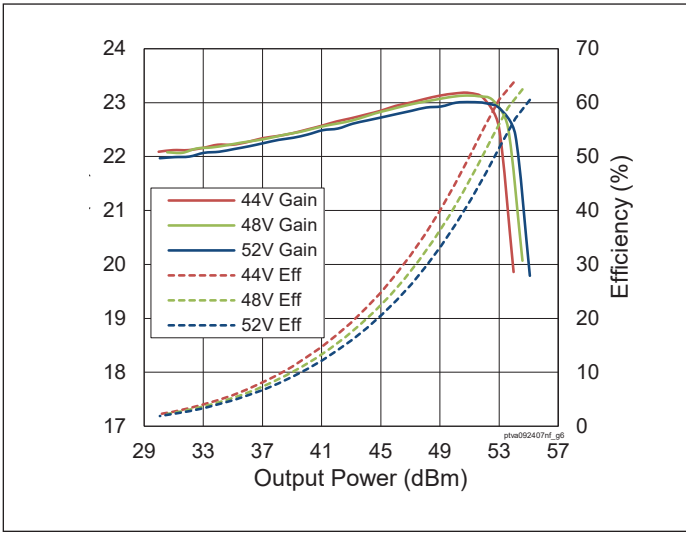


**Figure 4.** CW Performance

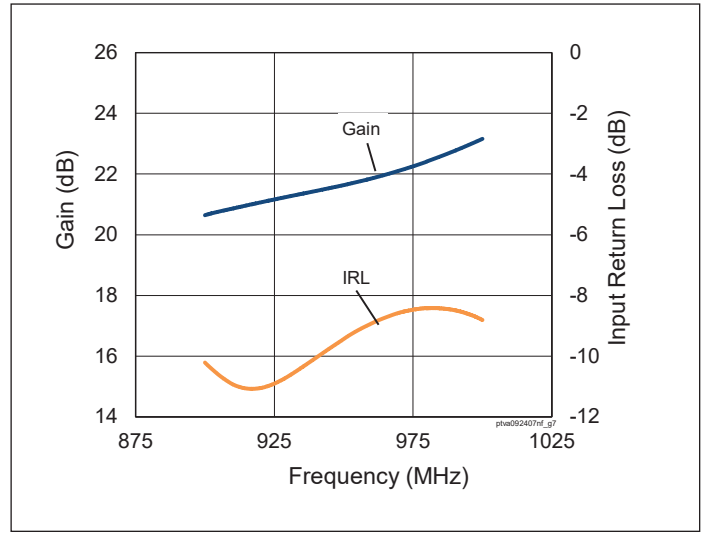
$V_{DD} = 48\text{ V}$ ,  $I_{DQ(MAIN)} = 900\text{ mA}$



**Typical RF Performance (cont.)**



**Figure 5. CW Performance at various  $V_{DD}$**   
 $I_{DQ(MAIN)} = 900 \text{ mA}$ ,  $f = 960 \text{ MHz}$



**Figure 6. CW Performance Small Signal Gain & Input Return Loss**  
 $V_{DD} = 48 \text{ V}$ ,  $I_{DQ(MAIN)} = 900 \text{ mA}$

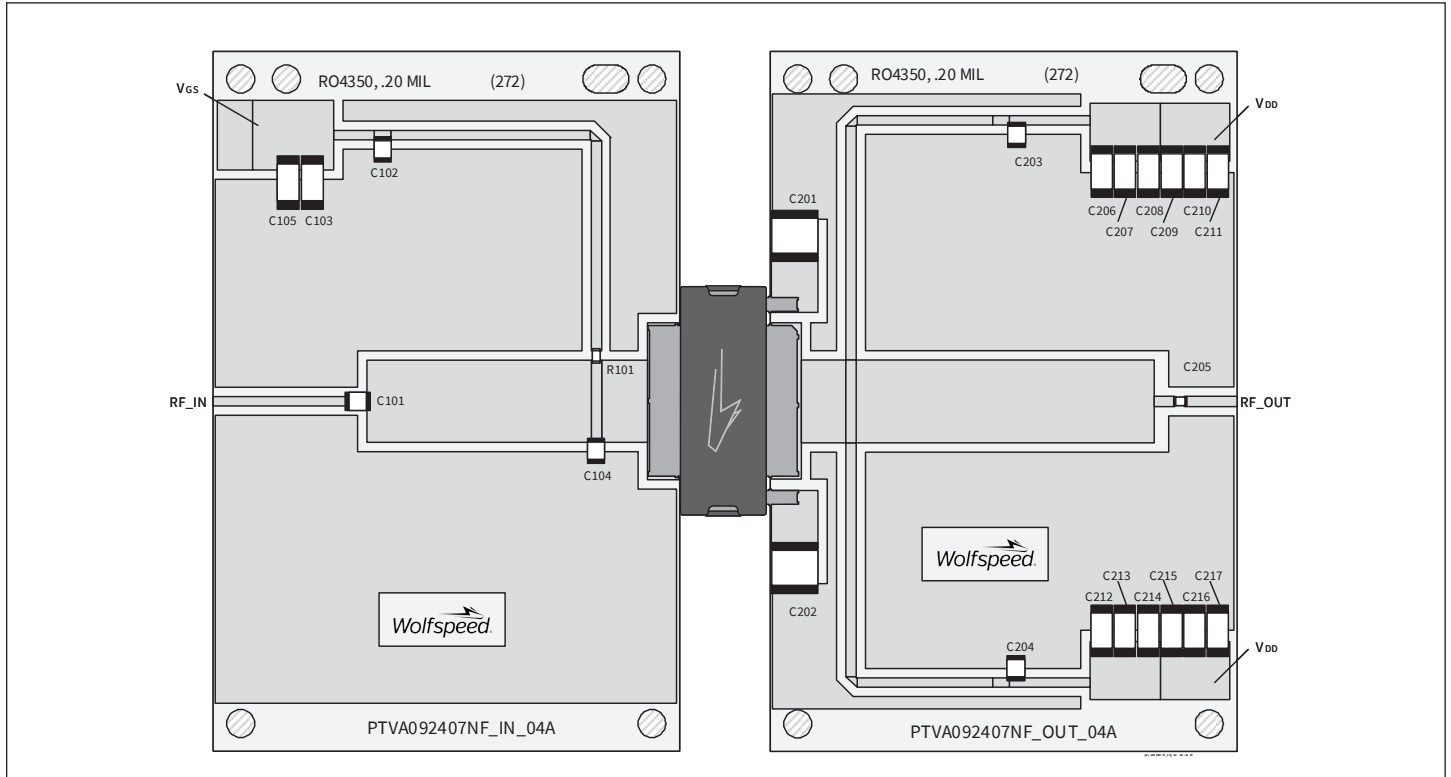
**Load Pull Performance**

**Each Side Load Pull Performance** – Pulsed CW signal: 10  $\mu\text{s}$ , 10% duty cycle, 48 V,  $I_{DQ} = 480 \text{ mA}$

		$P_{1dB}$									
		Max Output Power					Max Drain Efficiency				
Freq [MHz]	$Z_s [\Omega]$	$Z_l [\Omega]$	Gain [dB]	$P_{1dB}$ [dBm]	$P_{1dB}$ [W]	$\eta_D$ [%]	$Z_l [\Omega]$	Gain [dB]	$P_{1dB}$ [dBm]	$P_{1dB}$ [W]	$\eta_D$ [%]
869	0.69-j3.06	1.52-j0.62	20.83	55.70	371.54	57.6	2.72+j1.29	23.07	53.51	224.39	71.3
925	1.29-j3.32	1.46-j0.56	21.35	55.55	354.81	60.4	2.24+j1.18	23.44	53.27	212.32	70.5
960	2.45-j3.23	1.31-j0.55	21.52	55.51	355.63	59.9	2.01+j0.7	23.39	53.66	232.27	71.7

		$P_{3dB}$									
		Max Output Power					Max Drain Efficiency				
Freq [MHz]	$Z_s [\Omega]$	$Z_l [\Omega]$	Gain [dB]	$P_{3dB}$ [dBm]	$P_{3dB}$ [W]	$\eta_D$ [%]	$Z_l [\Omega]$	Gain [dB]	$P_{3dB}$ [dBm]	$P_{3dB}$ [W]	$\eta_D$ [%]
869	0.69-j3.06	1.55-j0.78	18.81	56.40	436.52	60.0	2.81+j1.47	21.17	53.84	242.1	71.9
925	1.29-j3.32	1.58-j0.7	19.43	56.30	426.58	63.2	2.27+j1.17	21.46	53.90	245.47	72.6
960	2.45-j3.23	1.41-j0.54	19.72	56.17	414	64.7	1.76+j0.92	21.5	53.87	243.78	72.7

## Evaluation Board, 869 – 960 MHz



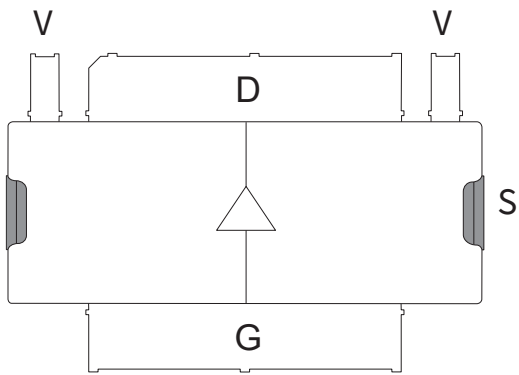
Reference circuit assembly diagram (not to scale)

Evaluation Board Part Number	LTN/PTVA092407NF-V2
PCB Information	Rogers 4350, 0.508 mm [0.020"] thick, 2 oz. copper, $\epsilon_r = 3.66$ , $f = 869 - 960$ MHz

Find Gerber files for this test fixture on the Wolfspeed Web site at [www.wolfspeed.com/RF](http://www.wolfspeed.com/RF)

### Components Information

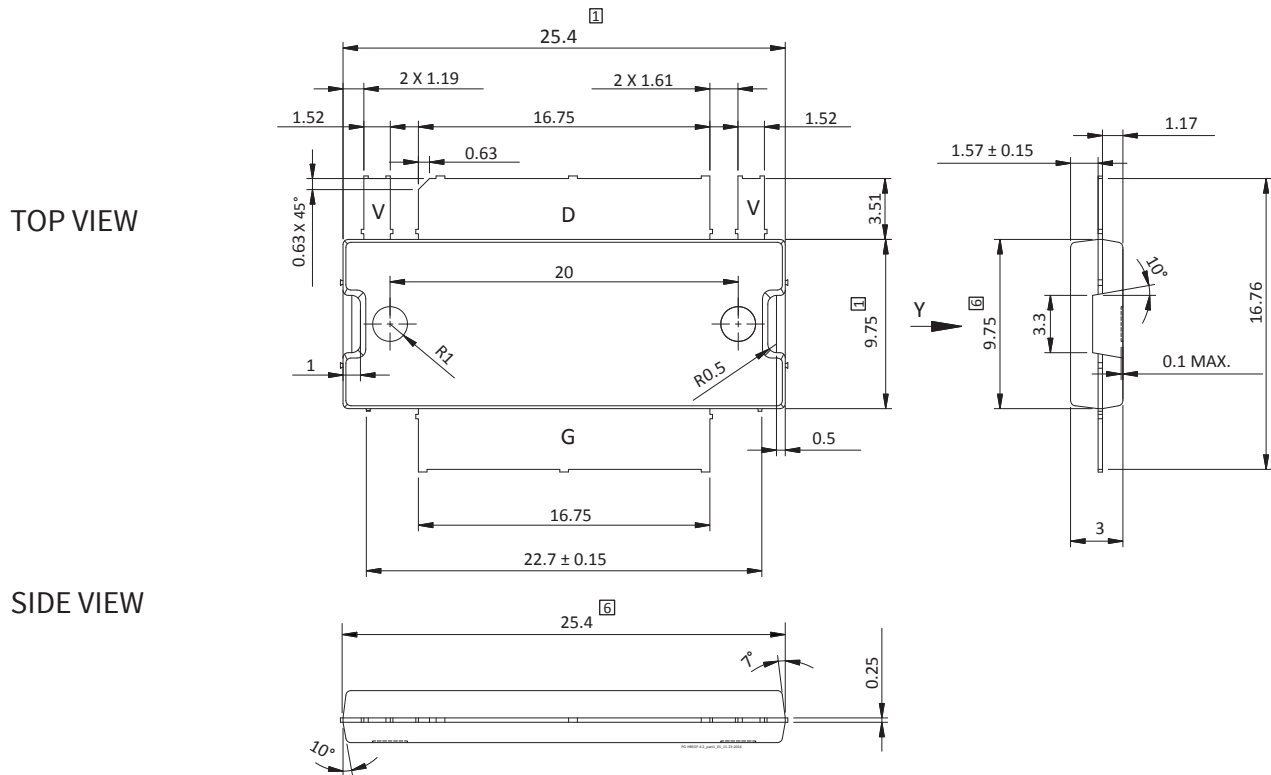
Component	Description	Manufacturer	P/N
<b>Input</b>			
C101	Capacitor, 47 pF	ATC	ATC100B470KW500XT
C102	Capacitor, 75 pF	ATC	ATC100B750KW500XT
C103, C105	Capacitor, 10 $\mu$ F, 100 V	TDK Corporation	C5750X7S2A106M230KB
C104	Capacitor, 3.6 pF	ATC	ATC100B3R6CW500XT
R101	Resistor, 10 ohms	Panasonic Electronic Components	ERJ-8GEYJ100V
<b>Output</b>			
C201, C202, C206, C207, C208, C209, C210, C211, C212, C213, C214, C215, C216, C217	Capacitor, 10 $\mu$ F, 100 V	TDK Corporation	C5750X7S2A106M230KB
C203, C204	Capacitor, 75 pF	ATC	ATC100B750KW500XT
C205	Capacitor, 10 pF	ATC	ATC100A101JW150XT

**Pinout Diagram** (top view)

Pin	Description
D	Drain
G	Gate
S	Source (flange)
V	Drain video decoupling (use only for decoupling), not for DC bias



## Package Outline Specifications – Package PG-HBSOF-4-2



### Diagram Notes—unless otherwise specified:

1. Mold/dam bar/metal protrusion of 0.30 mm max per side not included.
2. Metal protrusion are connected to source and shall not exceed 0.10 mm max.
3. Fillets and radii: all radii are 0.3 mm max.
4. Interpret dimensions and tolerances per ISO 8015.
5. Dimensions are mm.
6. Does not include mold/dam bar/metal protrusion.
7. Exposed metal surface tin-plated, may not be covered by mold compound.
8. All tolerances ± 0.1 mm unless specified otherwise.
9. All metal surfaces are tin-plated, except area of cut.
10. Lead thickness: 0.25 mm.
11. Pins: D – drain; G – gate; S – source; V – drain video decoupling (use only for decoupling), not for DC bias

## Package Outline Specifications (cont.) – Package PG-HBSOF-4-2

BOTTOM VIEW

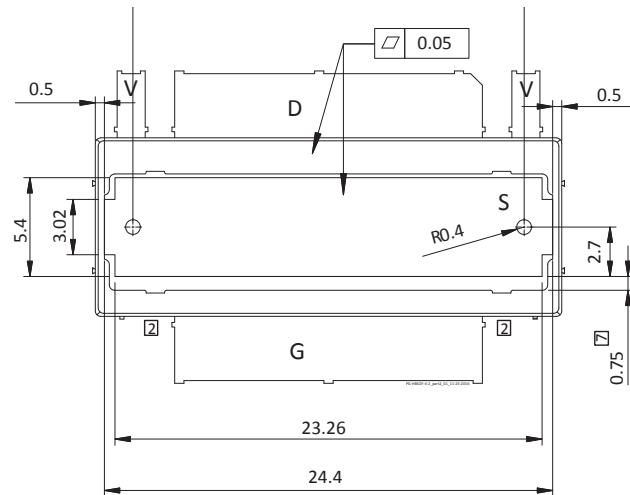


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